

U.S. Patent Application Serial No. 10/015,564  
Supplemental Amendment dated August 13, 2003  
Reply to OA of April 11, 2003

**REMARKS**

Claims 24-58 are pending in this application. Claim 53 has been amended and new claims 54-58 have been added herein.

In the Amendment filed on August 11, 2003, inadvertent mistakes were made in the presented claim amendments. The present Supplemental Amendment corrects typographical errors in claim 53 and adds claims 54-58, which were accidentally omitted from the Amendment.

Applicants request consideration of the Remarks in the Amendment dated August 11, 2003. Applicants respectfully note that on page 17, lines 16-17 of the Amendment, there is an inadvertent repetition of the phrase "composition comprising an epoxy resin as a thermosetting resin", and Applicants request notation of this error when reading the Remarks.


U.S. Patent Application Serial No. 10/015,564  
Supplemental Amendment dated August 13, 2003  
Reply to OA of April 11, 2003

If, for any reason, it is felt that this application is not now in condition for allowance, the Examiner is requested to contact Applicants undersigned agent at the telephone number indicated below to arrange for an interview to expedite the disposition of this case.

In the event that this paper is not timely filed, Applicants respectfully petition for an appropriate extension of time. Please charge any fees for such an extension of time and any other fees which may be due with respect to this paper, to Deposit Account No. 01-2340.

Respectfully submitted,

ARMSTRONG, WESTERMAN & HATTORI, LLP

  
Daniel A. Geselowitz, Ph.D.  
Agent for Applicants  
Reg. No. 42,573

DAG/plb  
Atty. Docket No. 011709  
Suite 1000  
1725 K Street, N.W.  
Washington, D.C. 20006  
(202) 659-2930



23850

PATENT TRADEMARK OFFICE